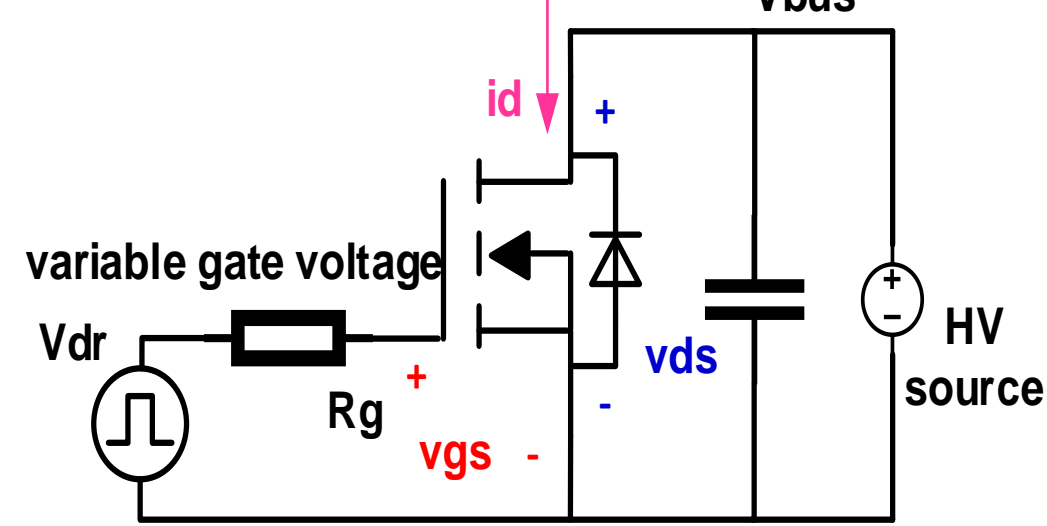


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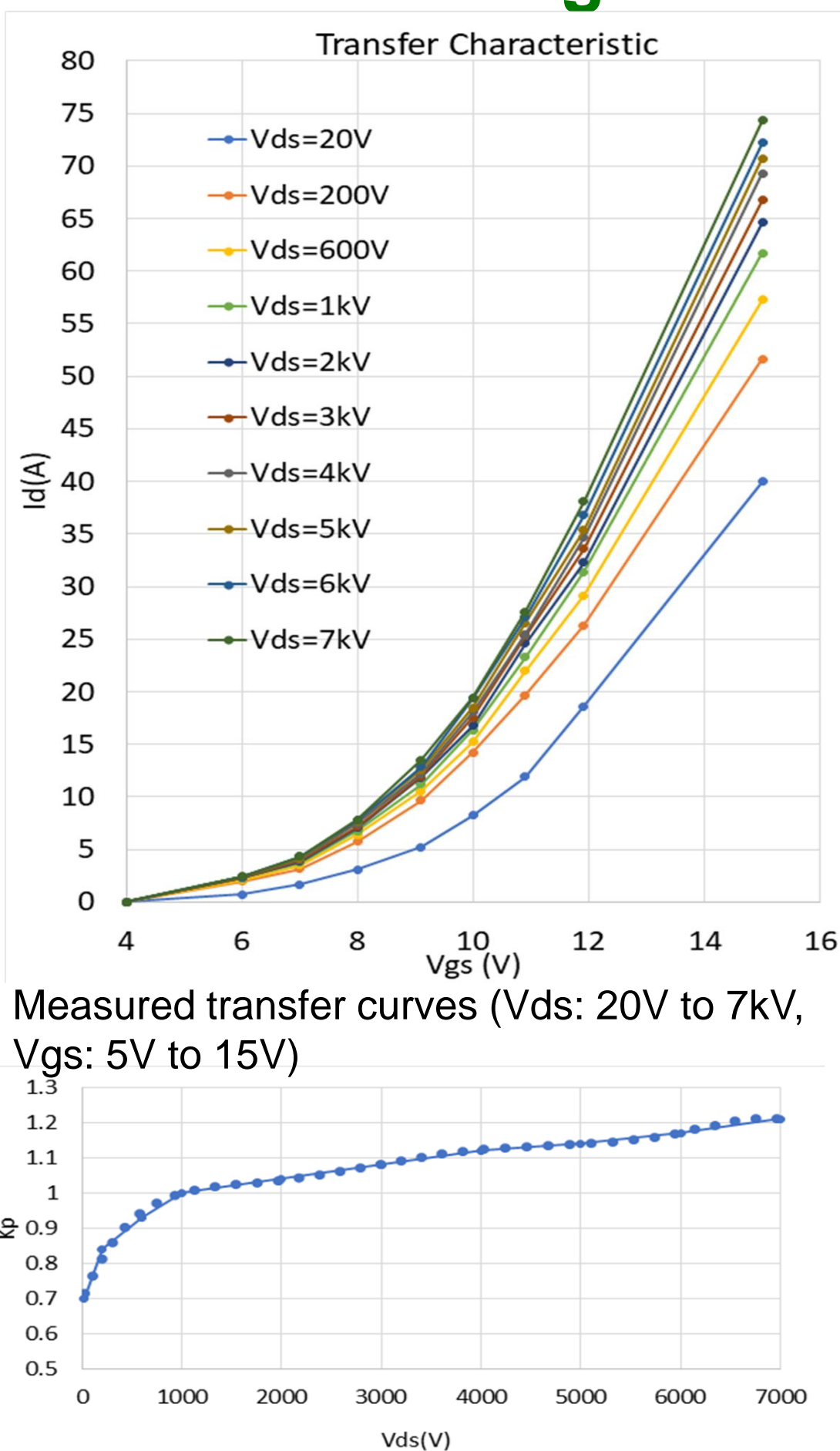
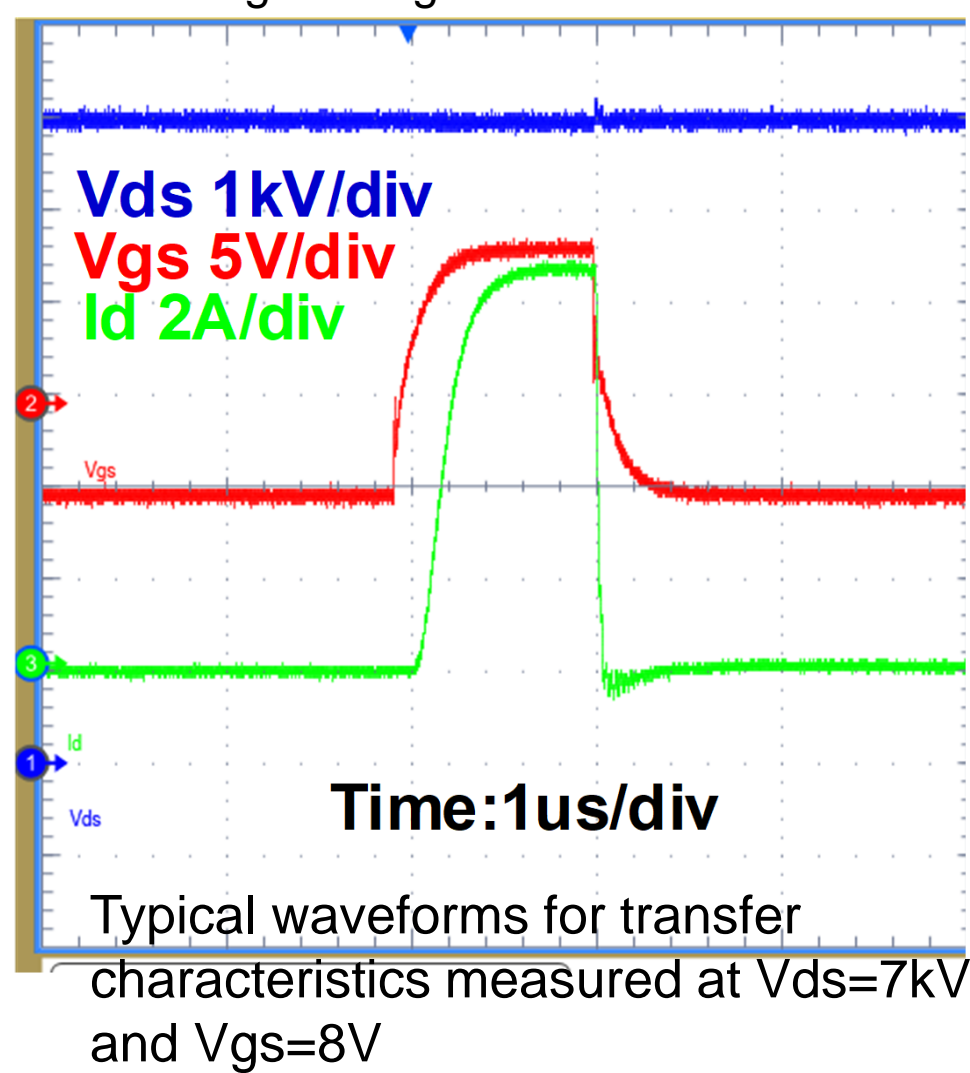
Background

- The emerging 10 kV SiC MOSFET brings great benefit for medium and high voltage applications. Accurate switching transient modeling of the 10 kV SiC MOSFETs is critical for successful application.
- Conventional models based on curve tracer results fail to consider transconductance and dynamic gate charge during actual high voltage turn-on switching transient, and shows obvious discrepancies compared to experiments.
- Transconductance varies under different drain-source voltage due to SiC MOSFET short channel effect and drain induced barrier lowering effect. Dynamic gate-drain charge under MOSFET channel turn-on condition is different from static gate-drain charge when MOSFET channel is off.

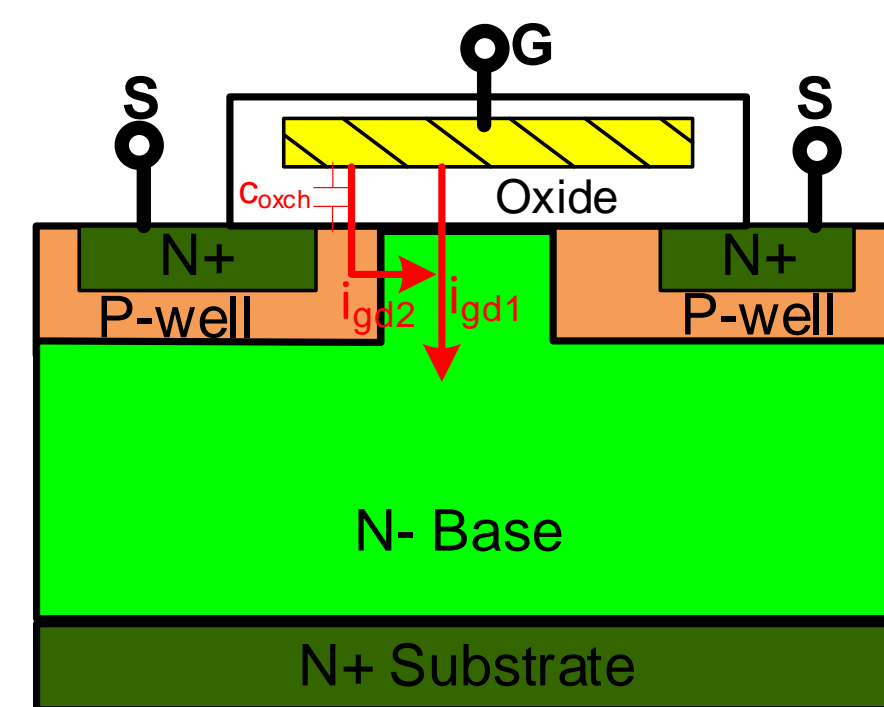
High Voltage Transconductance During Turn-on Transient



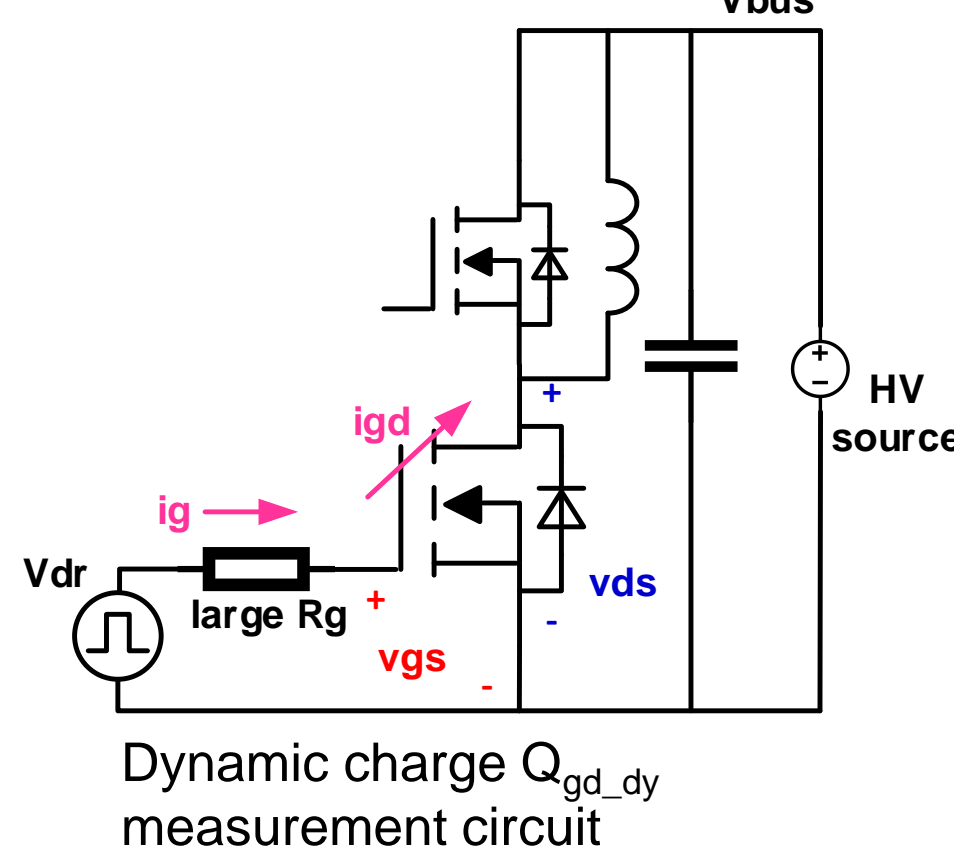
Transfer characteristics measurement circuit at high voltage



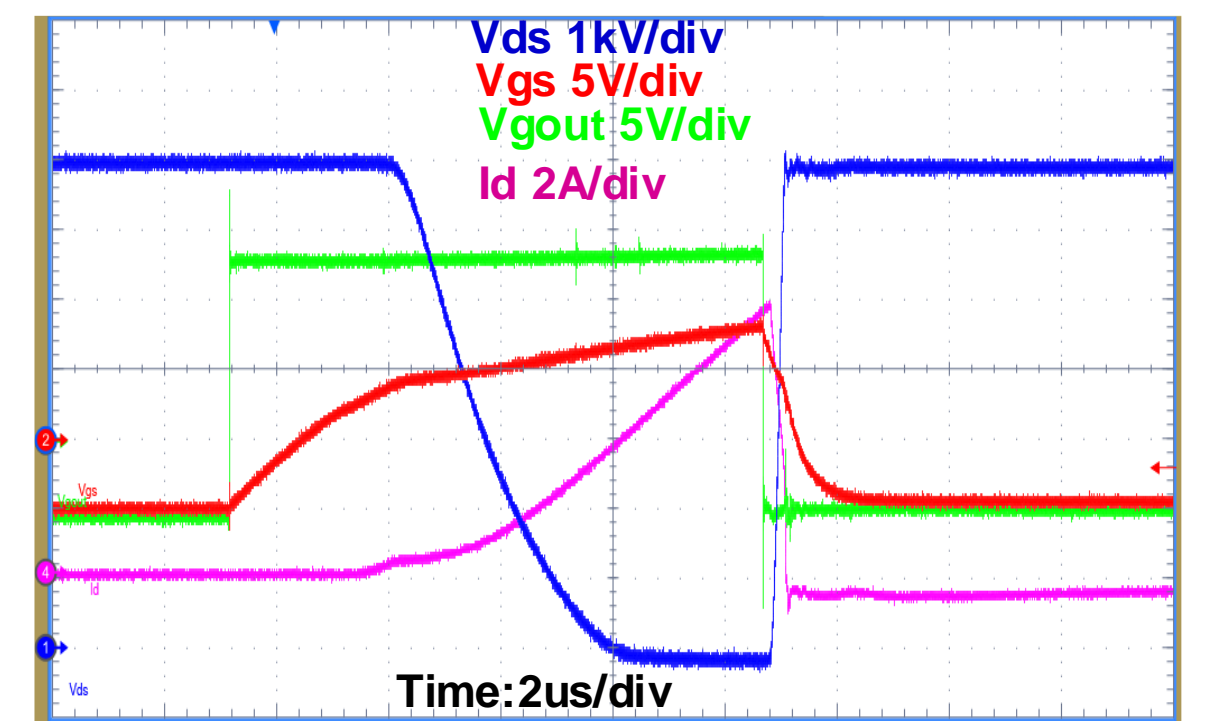
Dynamic Gate-drain Charge During Turn-on Transient



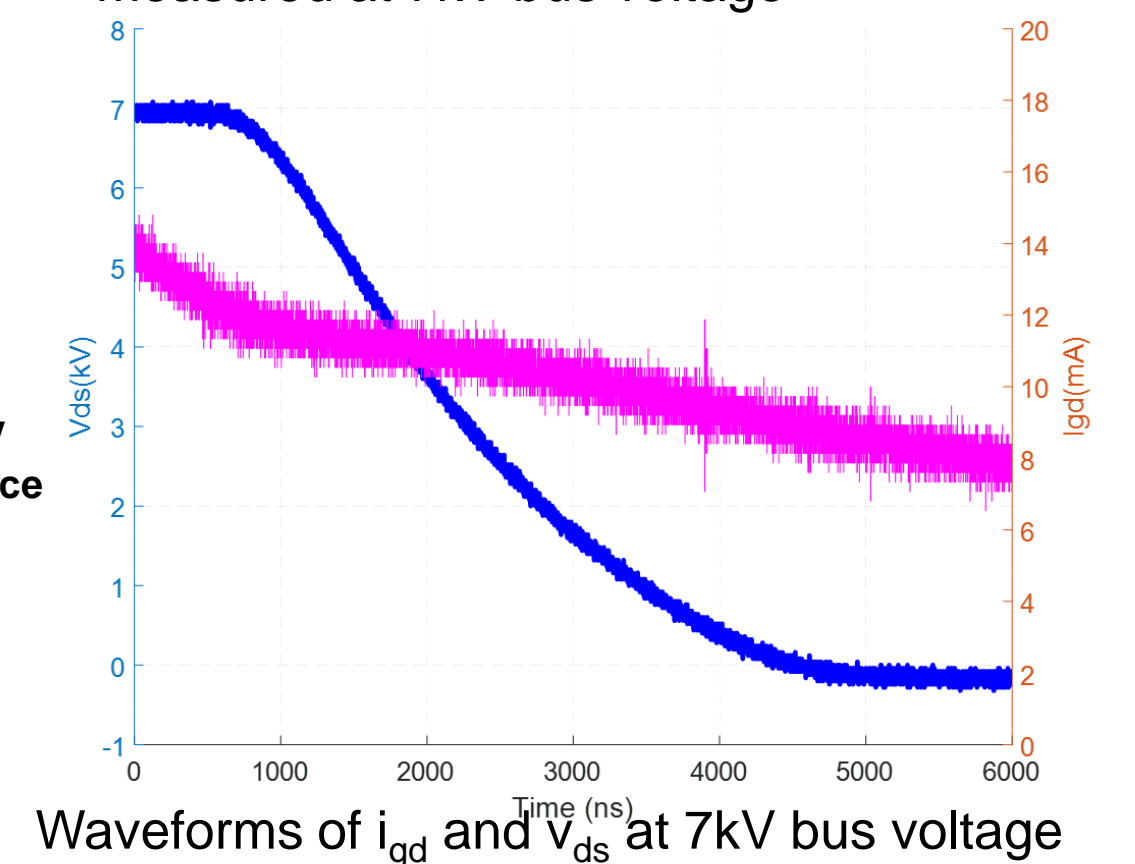
Simplified illustration of i_{gd} during turn-on switching transient



Dynamic charge Q_{gd_dy} measurement circuit

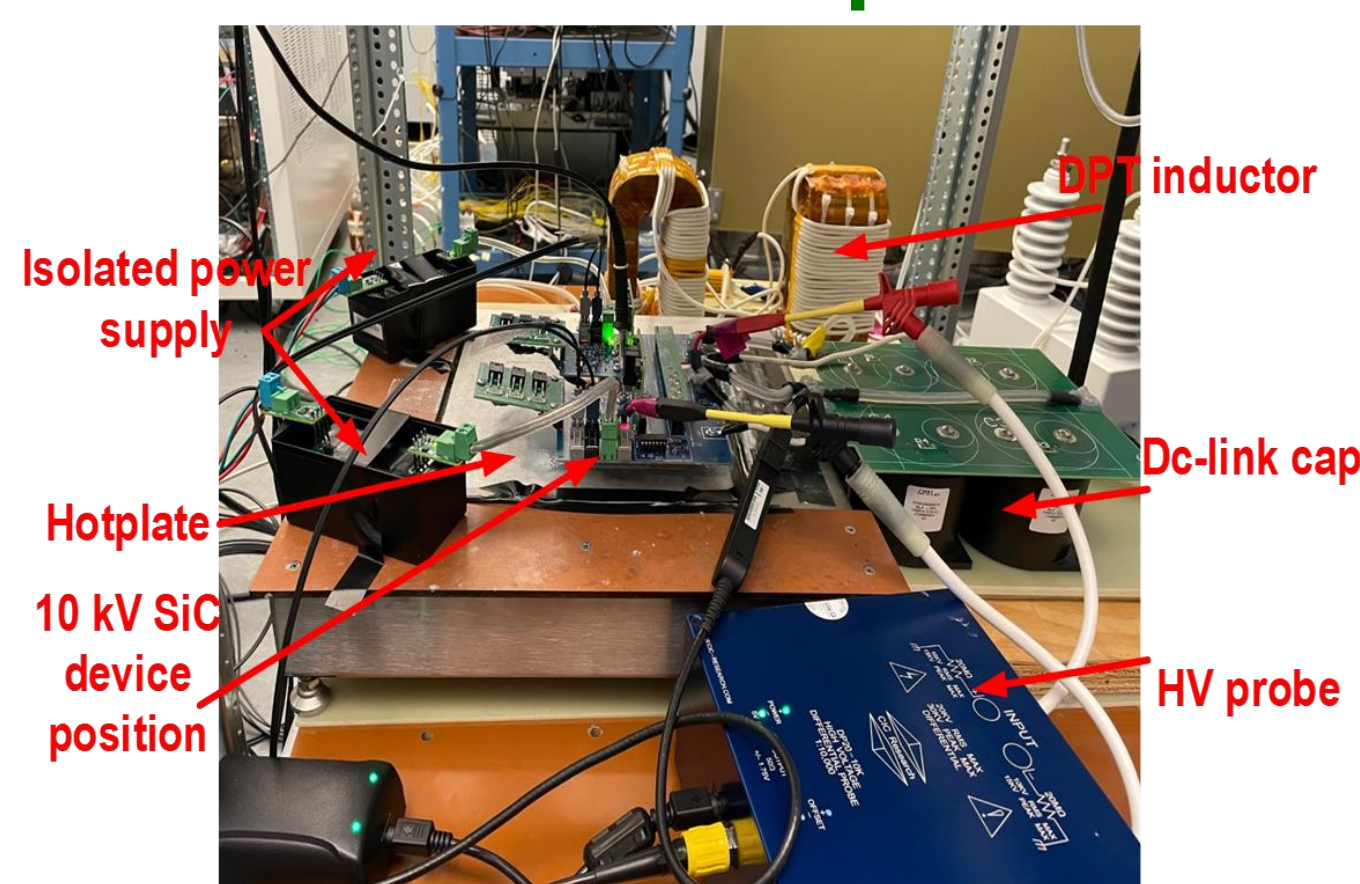


Typical waveforms for dynamic Q_{gd_dy} measured at 7kV bus voltage



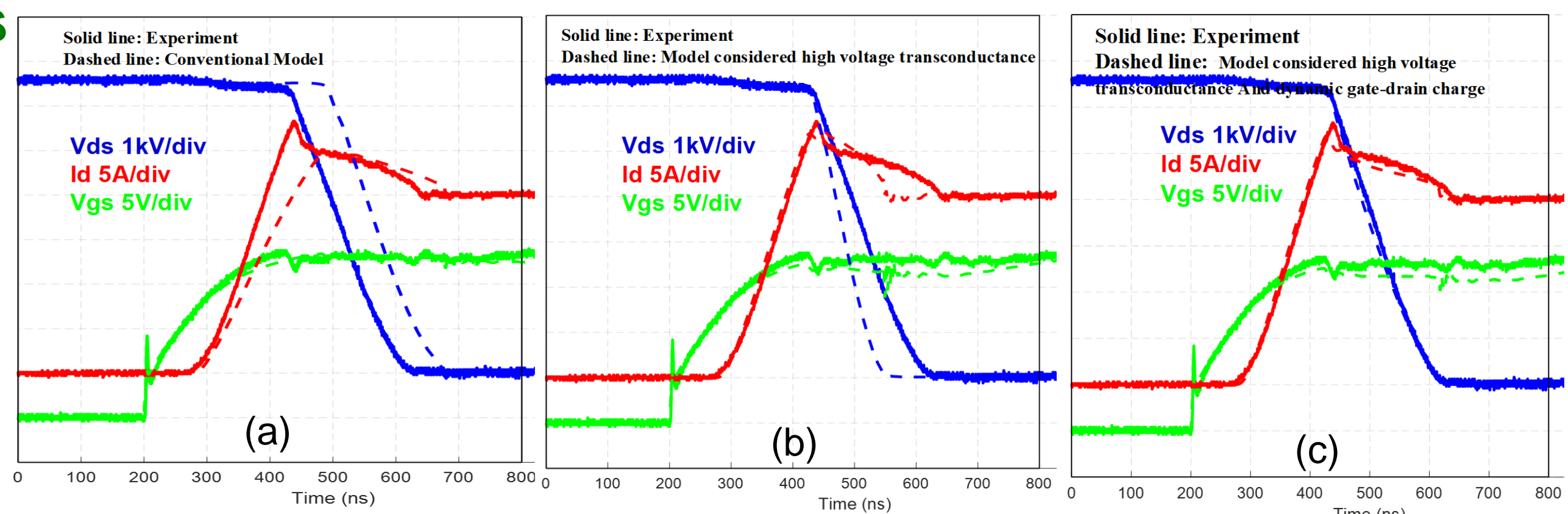
Waveforms of i_{gd} and V_{ds} at 7kV bus voltage

Improved Model and Experimental Results

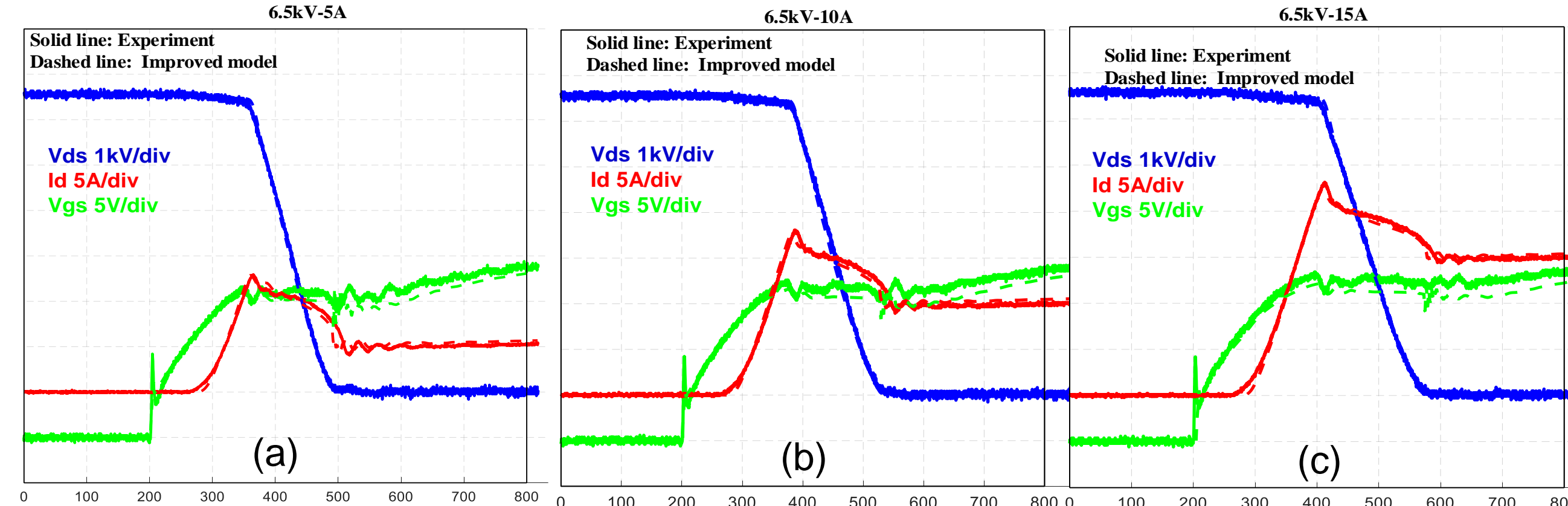


Parameters	Value
transconductance factor	$k_p = 0.7$
k_p	
threshold voltage v_T	$v_T = 4.1V (25^\circ C)$
R_B	380 mΩ
C_{gs}	6.3 nF
parameters for C_{gd}	$C_{gdi} = 1000 pF, C_{gdb} = 50 pF$ $M = 1/3$
parameters for C_{ds}	$C_{dsi} = 10 nF, C_{dsb} = 2.5 nF$ $M = 1/2$

	5A	10A	15A	20A
Eon (mJ)				
Experiment	7.3	12.03	18.25	26.02
Proposed Model	7.23	11.85	17.87	25.46
	(-0.96%)	(-1.5%)	(-2.08%)	(-2.15%)
Conventional Model	7.1	12.38	19.75	30.49
	(-1.78%)	(+2.91%)	(+8.22%)	(+17.18%)



Turn-on transient waveforms comparison at 6.5 kV/20A. (a) conventional model, (b) model considering high voltage transconductance, (c) model considering both high voltage transconductance and dynamic gate charge.



Turn-on transient waveforms comparison between the experiments and the proposed improved model at 6.5kV and different load conditions. (a) 5A, (b) 10A, (c) 15A.

Conclusions

- An improved turn-on switching transient model of the 10kV SiC MOSFET which considers the high voltage transconductance and dynamic gate-drain charge during turn-on transient is proposed and experimentally verified.
- With the proposed model, both current rise stage and voltage fall stage waveforms during turn-on transient match well with that in the experiment. The loss error is within 5% over wide load conditions.

